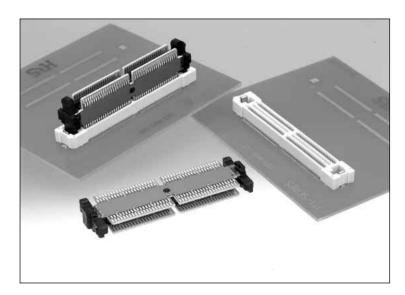
High Speed, Matched-Impedance, Parallel Board-to-board Connector

IT1 Series



IT1 Series Outline

High-speed matched-impedance parallel board-to-board connector designed for applications requiring board-toboard spacing with transmission speeds exceeding 1GHz. The connection system has matched impedance of 50 ohm or can be customized. Contacts are on 0.5mm pitch.

■Features

1. Impedance Matching using a 4-Layer Board

The innovative transmission module uses PC boards with a strip line design of transmission lines, providing matched impedance of 50 ohms, for standard product.

2. Supports Multiple Connectors per board

Designed with a tolerance of +/- 0.2mm for both the X and Y-axis. The three-piece structure and the +/- 0.2mm tolerance allows 3 or more IT1's to be mounted on a single board.

3. Customized Board-to-Board Distance

Board-to-board distance can be customized, from 16mm to 40mm.

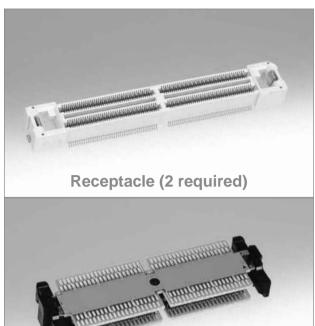
Ground lines or additional traces can be added to support high level, high speed transmission or mixed power/signal applications.

4. Signal to Ground Ratio

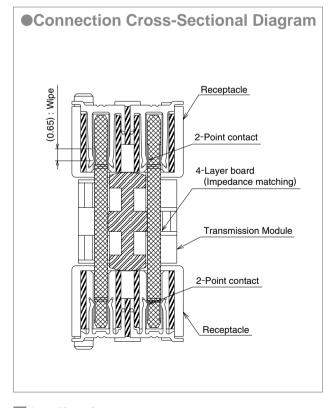
The standard signal-to-ground ratio is 10:2, which makes reliable matching of the characteristic impedance of each transmission line. This ratio also can be customized.

5. Contact Reliability

Use of double contact points on each of the contacts assures highly reliable performance.



Transmission Module



Applications

Routers, servers, base stations and other telecommunication equipment.

■Product Specifications

Poting	Current rating	0.4 A (Note 1)	Operation Temperature Range	-55℃ to +85℃	Storage Temperature Range	-10°C to +60°C (Note 2)
Rating	Voltage rating	50V AC	Operation Humidity Range	Relative humidity 95% max. (No condensation)	Storage Humidity Range	40% to 70% (Note 2)

Item	Specification	Conditions
1. Insulation resistance	100 M ohms min.	Measured at 100V DC
2. Withstanding voltage	No flashover or insulation breakdown	150 V AC/one minute
3. Contact resistance	100 m ohms max.	Measured at 100 mA
4. Vibration	No electrical discontinuity of 1 μs or more. No damage, cracks, or parts dislocation.	Frequency of 10 to 55 Hz, 0.75mm single amplitude, for 10 cycles in each of 3 directions
5. Shock	No electrical discontinuity of 1 μ s. min. No damage, cracks, or parts dislocation	Acceleration of 490 m/s², 11 ms duration, sine half-wave waveform, 3 cycles in each of the 3 axis.
6. Humidity	Contact resistance: 110 m ohms max. Insulation resistance: 100 M ohms min. No damage, cracks, or parts dislocation	96 hours/40°C/ humidity of 90% to 95%
7. Temperature cycle	Contact resistance: 110 m ohms max. Insulation resistance: 100 M ohms min. No damage, cracks, or parts dislocation	Temperature: -55° \rightarrow +15°C to +35°C \rightarrow +85°C \rightarrow +15°C to +35°C Duration: 30 \rightarrow 2 to 3 \rightarrow 30 \rightarrow 2 to 3 (Minutes) 5 cycles
8. Durability (insertion/ withdrawal)	Contact resistance: 110 m ohms max. No damage, cracks, or parts dislocation.	20 cycles
Resistance to Soldering Heat	No deformation of components affecting performance.	Reflow: At the recommended temperature profile Manual soldering: 350°C for 3 seconds

Note1: If the connector is going to be used at a current in excess of the 0.4 A, please contact your Sales Representative.

Note2: The term "storage" refers to products stored for long period of time prior to mounting and use. Operating Temperature Range and Humidity range covers non- conducting condition of installed connectors in storage, shipment or during transportation.

Note3: Information contained in this catalog represents general requirements for this Series. Contact us for the drawings and specifications for a specific part number shown.

■Material

Receptacles

Part	Material	Finish	Remarks
Insulator	LCP	Color : Beige	UL94V-0
Contacts	Phosphor bronze	Gold plating	
Metal fittings	Phosphor bronze	Tin plating	

Transmission Module

Part	Material	Finish	Remarks
Insulator	PBT	Color : Black	UL94V-0
Board	FR-4	Contact portion : Gold plating	

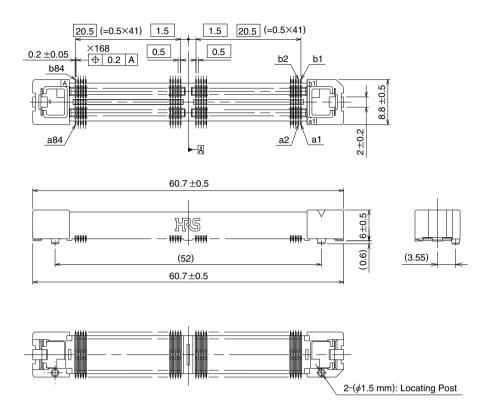
■Ordering information

Receptacles

Transmission Module

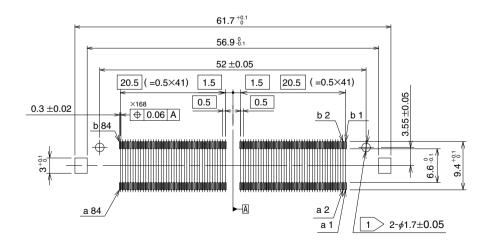
Series name	: IT1	5 Lead
2 Locating Post type Blank	: With Locating Post	SV : Straight SMT
Α	: Without Locating Post	Packaging
Number of contacts	: 168, 252	Blank : Tray
4 Connector S	: Receptacle Socket	(25): Tray(connectors with attached tape
P	: Transmission Plug Module	for a vacuum board placement)
		Number of ground contacts: 28, 44
		Board-to-board Distance: 19mm,23mm,30mm

■Receptacles - 168 Contacts



Part Number	CL No.	Locating Post Type	RoHS
IT1-168S-SV	641-0002-0	With Locating Post	VEC
IT1A-168S-SV	641-0012-4	Without Locating Post	YES

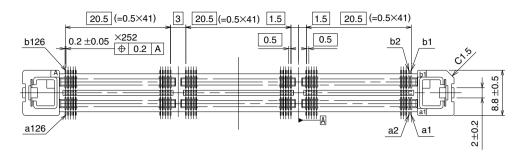
●Recommended PCB mounting pattern

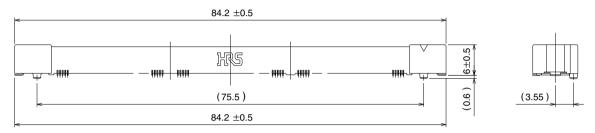


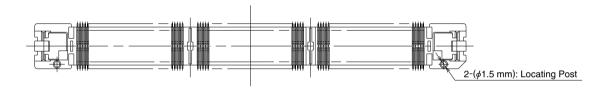
1 Not required for products without Locating Post.

A296 **HS**

■Receptacles - 252 Contacts

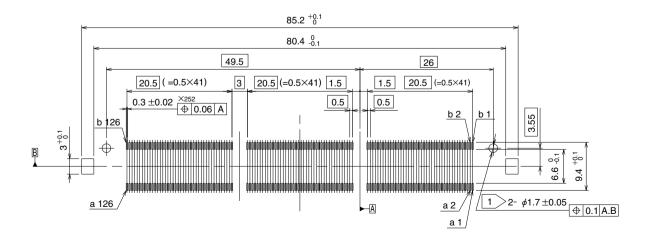






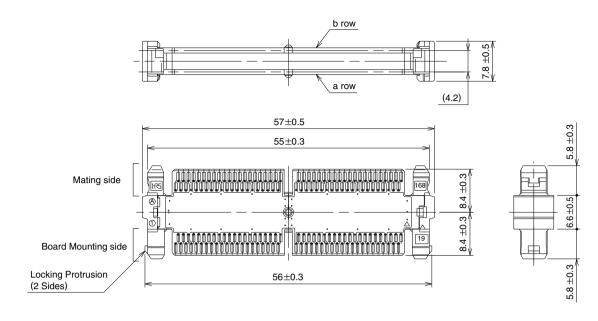
Part Number	CL No.	Locating Post Type	RoHS
IT1-252S-SV	641-0003-3	With Locating Post	VEC
IT1A-252S-SV	641-0013-7	Without Locating Post	YES

♠ Recommended PCB mounting pattern



1 Not required for products without locating Post.

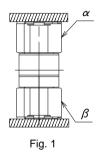
■Transmission Module - 168 Contacts



Part Number	CL No.	Board-to-board Distance	А	В	С	RoHS
IT1-168P/28-19H	641-0192-8	19mm	8.4	8.4	6.6	YES
IT1-168P/28-30H	641-0303-7	30mm	13.9	13.9	17.6	TES

■Connection Table

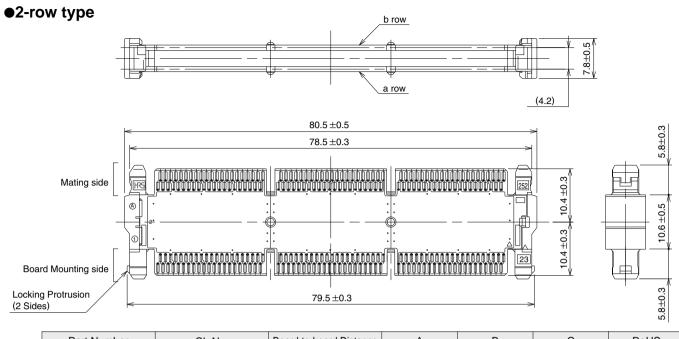
The connection table indicates contact numbers in the mated condition, as illustrated in Fig. 1.



	a row					
	α - β		α - β			
	a 1-a84		a44 - a41			
	a 2-a83		!!!			
Signal	a 3-a82	Signal				
	a 4 - a81		ii			
	a 5-a80		a53 - a32			
Ground	a 6-a79	Ground	a54 - a31			
Olouliu	a 7 - a78	Oround	a55 - a30			
	a 8-a77		a56 - a29			
Signal		Signal				
	1 1		1 1			
	a17 - a68		a65 - a20			
Ground	a18 - a67	Ground	a66 - a19			
	a19 - a66		a67 - a18			
	a20 - a65		a68 - a17			
Signal		Signal				
	i i		i i			
	a29 - a56		a77 - a 8			
Ground	a30 - a55	Ground	a78 - a 7			
	a31 - a54		a79 - a 6			
	a32 - a53		a80 - a 5			
			a81 - a 4			
Signal		Signal	a82 - a 3			
	i i		a83 - a 2			
	a41 - a44		a84 - a 1			
Ground	a42 - a43					
Oround	a43 - a42					

b row					
	α - β		α-β		
	b 1 - b84		b44 - b41		
	b 2-b83		!!!		
Signal	b 3-b82	Signal			
	b 4 - b81				
	b 5 - b80		b53 - b32		
Ground	b 6-b79	Ground	b54 - b31		
Giouna	b 7 - b78	Giouna	b55 - b30		
	b 8 - b77		b56 - b29		
Signal		Signal			
	b17 - b68		b65 - b20		
C	b18 - b67	0	b66 - b19		
Ground	b19 - b66	Ground	b67 - b18		
	b20 - b65		b68 - b17		
Signal		Signal			
	b29 - b56		b77 - b 8		
Ground	b30 - b55	Ground	b78 - b 7		
Giouna	b31 - b54	Giouna	b79 - b 6		
	b32 - b53		b80 - b 5		
Signal	1 1		b81 - b 4		
		Signal	b82 - b 3		
			b83 - b 2		
	b41 - b44		b84 - b 1		
Ground	b42 - b43				
Giouna	b43 - b42				

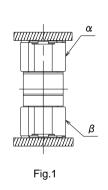
■Transmission Module - 252 Contacts



Part Number	CL No.	Board-to-board Distance	Α	В	С	RoHS
IT1-252P/44-23H	641-0231-8	23mm	10.4	10.4	10.6	YES
IT1-252P/44-30H	641-0304-0	30mm	13.9	13.9	17.6	TES

■Connection Table

The connection table indicates contact numbers in the mated condition, as illustrated in Fig. 1.

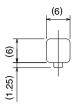


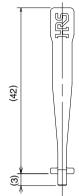
			a row		
	α - β		α - β		α - β
	a 1 - a126		a44 - a83		a86 - a41
Signal		Signal	552 -74	Signal	
	a 5 - a122		a53 - a74		a95 - a32
Ground	a 6 - a121 a 7 - a120	Ground	a54 - a73 a55 - a72	Ground	a96 - a31 a97 - a30
	a 8 - a119		a56 - a71		a98 - a29
Signal		Signal		Signal	
	a17 - a110		a62 - a65		a107 - a20
Ground	a18 - a109	Ground	a63 - a64	Ground	a108 - a19
	a19 - a108		a64 - a63	Oloulu	a109 - a18
	a20 - a107		a65 - a62		a110 - a17
Signal		Signal		Signal	
	a29 - a98		a71 - a56		a119 - a 8
Ground	a30 - a97	Ground	a72 - a55	Ground	a120 - a 7
Oround	a31 - a96	Orouna	a73 - a54	Orouna	a121 - a 6
	a32 - a95		a74 - a53	_	a122 - a 5
Signal	 	Signal		Signal	
	a41 - a86		a83 - a44		a126 - a 1
Ground	a42 - a85	Ground	a84 - a43		/
Giouria	a43 - a84	Ciouna	a85 - a42		

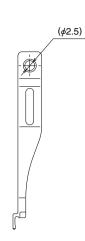
b row								
	α - β		α - β		α - β			
Signal	b 1 - b126	Signal	b44 - b83	Signal	b86 - b41			
	b 5 - b122		b53 - b74		b95 - b32			
Ground	b 6-b121	Ground	b54 - b73	Ground	b96 - b31			
	b 7 - b120		b55 - b72		b97 - b30			
Signal	b 8 - b119	Signal	b56 - b71	Signal	b98 - b29			
	b17 - b110		b62 - b65		b107 - b20			
Ground	b18 - b109	Ground	b63 - b64	Ground	b108 - b19			
	b19 - b108		b64 - b63		b109 - b18			
	b20 - b107	Signal	b65 - b62	Signal	b110 - b17			
Signal								
	b29 - b98		b71 - b56		b119 - b 8			
Ground	b30 - b97	Ground	b72 - b55	Ground	b120 - b 7			
	b31 - b96		b73 - b54		b121 - b 6			
Signal	b32 - b95		b74 - b53		b122 - b 5			
		Signal		Signal				
	b41 - b86		b83 - b44		b126 - b 1			
Ground	b42 - b85	Ground	b84 - b43					
	b43 - b84		b85 - b42					

◆IT1 Series Extraction Tool

Part Number CL No.		Remarks	RoHS
IT1-PICKER(1)	641-1001-3	2-piece Package	YES







Installation and Use Instruction Manual Table of Contents

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3. Connector Placement A304				
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3-2 Receptacle Vacuum Pick-and-Place Areas				
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◆ Connector Handling Precautions

1. System components

■Receptacles

Contacts

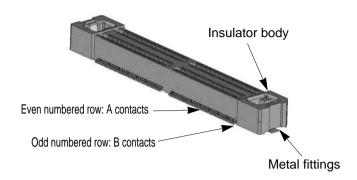
Row A and row B contacts are arranged alternately starting with No.1 in row B. Placement on board is polarized.

Metal Fittings

Permanently inserted to provide lock with the Transmission Module and additional solder areas with the PCB.

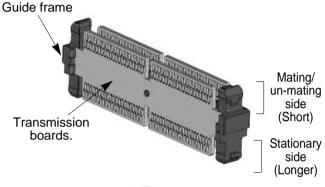
Insulator body.

Injection molded single unit provides protection and correct self-alignment of all components.



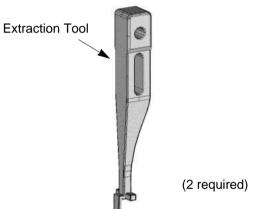
■Transmission Module Assembly

- Each Module has stationary side and a mating/un-mating side.
- When mounting multiple connectors, please keep uniform orientation of the stationary side.
- Transmission printed circuit boards used in the module are based on JIS standards and quality standards applicable to memory modules.



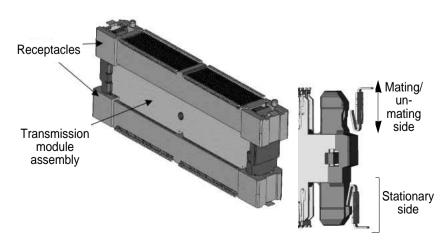
■Extraction Tool

• Used to release the transmission module from the stationary receptacle.



Fully Connected Condition

The interconnection package consists of 3 main sub-assemblies: Two receptacles and the Transmission Module. The transmission module, held securely by the guide frame has a mating/un-mating side and a stationary side. Once the stationary side is inserted in the receptacle, it can not be removed without the use of extraction tool. The mating/un-mating side allows repeated re-insertion of the receptacle on this side only.



2. Recommended Design Guidelines

2-1 Solder Land Pattern

When placing the receptacles on the Printed Circuit Boards using automatic mounting equipment or manually, assure that the correct diameters of the holes (Fig. 1) are through the entire thickness of the board.

♦Locating post hole diameter **♦**

The contacts of receptacle assembly are exposed on the bottom surfaces. The exposed areas of the contacts are a distance of 0.25 mm minimum from the surface of the Printed Circuit Board, on which the receptacle assembly is placed (Fig.2). Consideration should be taken not to place or assure insulation of conductive traces under the receptacle assemblies.

Refer to the separate drawings for recommended solder land pattern dimensions of the receptacle, and signals and ground connection diagram of the transmission module.

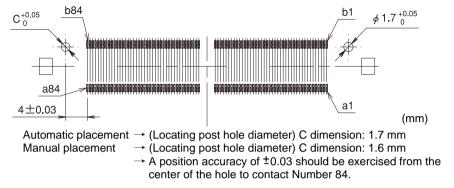


Fig. 1 IT1-168S-SV Recommended Solder Land Pattern

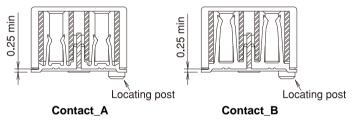


Fig. 2 Cross section of IT1 receptacle

2-2 Board-to-Board Spacer heights

The two parallel boards connected by the IT1 connectors should be fastened to additional spacers between them.

Fig. 3 indicates the connector height tolerance and the spacer's height.

When designing the spacer's height, consideration should be given to the solder paste thickness and any other features, which may affect the full mating of the connector.

Fig. 3 indicates design dimensions for the 19 mm board-to-board distance.

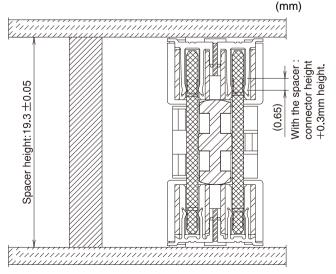


Fig. 3

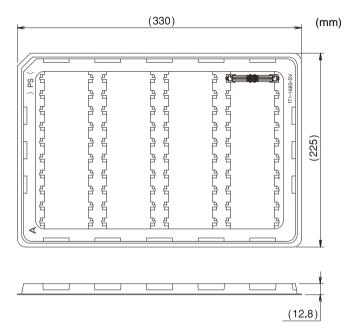
3. Connector Placement

3-1 Packaging Types

- Two types of packaging are available: semi-hard tray and hard tray. Customers may specify a packaging type suitable for their automatic placement machines.
- * Refer to the separate drawings for the detailed dimensions of the trays.

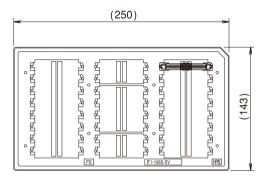
Semi-hard tray packaging

168 contacts receptacle: 40 pieces per tray 252 contacts receptacle: 30 pieces per tray



Hard tray packaging

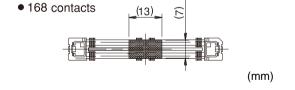
168 contacts receptacle: 24 pieces per tray 252 contacts receptacle: 16 pieces per tray

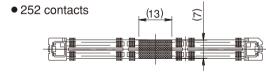




3-2 Automatic placement - Vacuum Pick-and-Place Areas

Specify "Vacuum Pick-up Tape Specification".
 The area and position of the pick-and-place surface are indicated in the diagrams below.





3-3 Receptacle Board Placement

- When using automatic placement equipment, verify the packaging type and the Pick-and-place areas.
- When placing manually, pay attention to the possibility of positional shift. Ref. Fig. 4.
- * When placing multiple connectors, to assure positional accuracy, it is advised to use automatic placement equipment.

♦ Precautions for Manual Placement **♦**

The orientation posts serve as a prevention measure to avoid incorrect placement of the receptacle assemblies on the board. The contact terminals must be placed correctly over the corresponding solder pad as shown on Fig. 4-1.

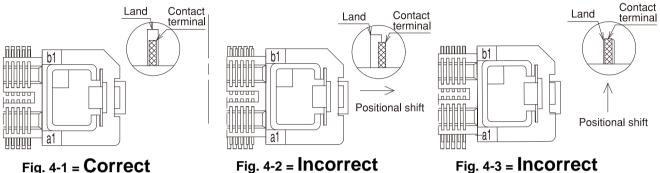
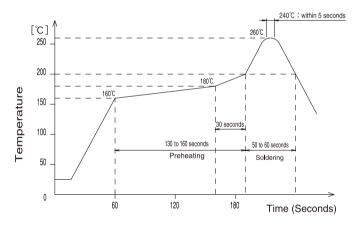


Fig. 4-3 = Incorrect

3-4 Recommended Reflow Conditions



Applicable Conditions

 Reflow system : IR reflow

Solder : Paste type (Sin:96.5, AG:3.0, Cu:5.0)

(Flux content 9wt%)

Test board : Glass epoxy (FR-4), 85mm x 110mm x 1.6 mm

• Metal mask thickness: 0.15 mm

* Shown recommended temperature profile.

3-5 Solder Repairs

Assure that flux is not reaching the contact areas of the connector. Wash the assembly as recommended below.

♦Cleaning Conditions **♦**

<Organic Solvent Cleaning>

Solvent Type	Normal temperature	Heated
IPA (Isopropyl alcohol)	Good	Good

<Water Based Cleaning>

When using water based cleaning agents (e.g., terpene, and alkali saponifiers), select the cleaning agent based on the documentation issued by the various manufacturers, which describes its effects on metals and resins. Care should be taken not to leave moisture on the connectors.

<Cleaning Precautions>

Residual flux or cleaning agent remaining on the connectors when cleaning with organic solvents or water based cleaners may cause deterioration of the electrical performance. It is important to check that a thorough washing has been performed.

4. Mating Procedure

Follow the procedure described below.

Note: • The transmission module must be fully inserted into receptacle assembly already placed and soldered to a board.

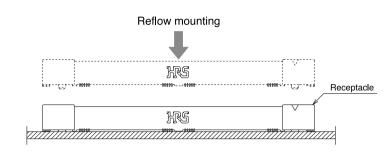
The Transmission Module cannot be exposed to heat temperatures of the soldering process.

Step 1

Receptacle Placement on the board – stationary side

Assure that the orientation posts are aligned with the holes on the board.

When specifying receptacle assemblies without the orientation posts exercise extra caution to assure correct orientation and connection with the solder pads.

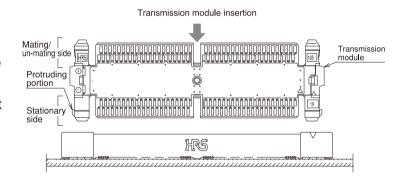


Step 2

Insertion of the Transmission Module

Fully insert the Transmission Module in the board-installed receptacle assembly.

It is critical that the insertion is done straight and uniformly.



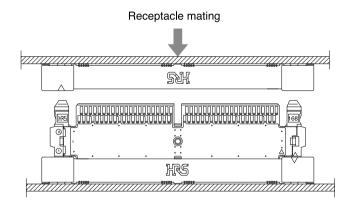
Step 3

Mating/un-mating

Assure that the receptacle assembly is correctly aligned with the Transmission Module.

Fully insert the receptacle assembly on the Transmission Module.

It is critical that the insertion is done straight and uniformly.



Connection completed

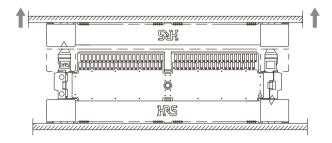
Step 4

Mating/ un-mating side Stationary side

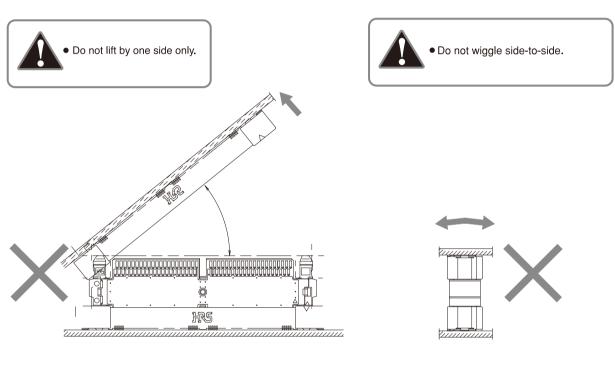
5. Un-mating of Connectors

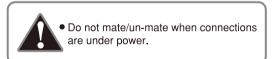
Recommended Method

• Pull uniformly straight up.



Prohibited un-mating Methods



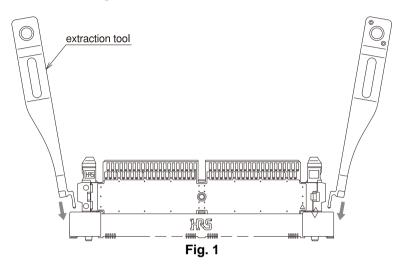


6. Removal of the Transmission Module - stationary side

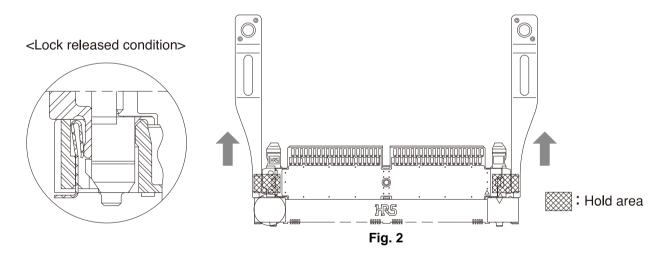
• Requires use of dedicated extraction tool. Two are required.

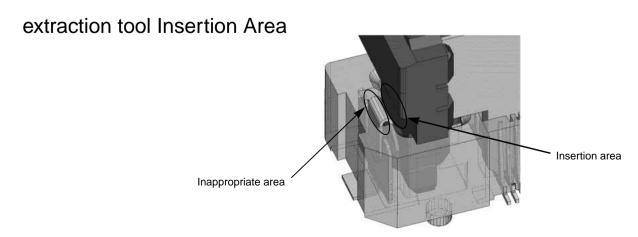
Step 1

 Fully insert the tools into each end of the receptacle assembly (Fig. 1) assuring that they will be over the hold areas of the Transmission Module frame. Ref. Fig. 2



Step 2 Pull out the transmission module holding the tools straight.



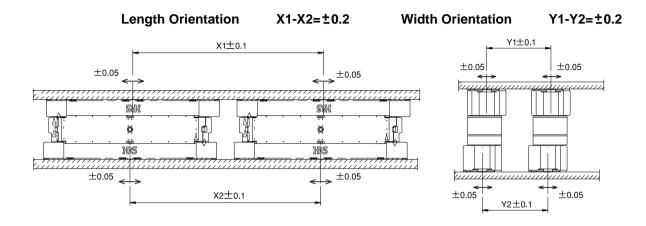


7. Precautions When Mounting Multiple Connectors

Note: Observe the requirements as listed in paragraph 7-1 and 7-2. The mating/un-mating forces will increase with use of multiple assemblies. It is recommended that a dedicated tooling is used for mating / un-mating of multiple connector assemblies in a single operation.

7-1 Allowable Amount of Misalignment

Maximum allowable misalignment in X and Y directions is ± 0.2 mm total. Refer to the drawings below.



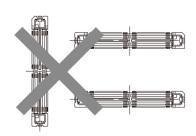
7-2 Recommended Connector Placement

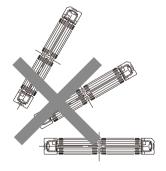
It is recommended to leave min. of 30 mm space between the adjacent connector assemblies.



7-3 Examples of Prohibited Placement Positions

To assure reliability of solder joints and mating/ un-mating without damage, DO NOT PLACE MULTIPLE CONNECTORS as illustrated below.





Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Hirose Electric:

<u>IT1-168S-SV</u> <u>IT1-168S-SV(25)</u> <u>IT1-168S-SV(26)</u> <u>IT1-168S-SV(46)</u> <u>IT1-252S-SV</u> <u>IT1-252S-SV(25)</u> <u>IT1-252S-SV(25)</u> <u>IT1-252S-SV(26)</u> <u>IT1-168P/28-19H(03)</u> <u>IT1-252P/44-23H</u> <u>IT1-252P/44-23H(03)</u> <u>IT1-168P/28-30H(03)</u> <u>IT1-168P/28-30H(03)</u>